

## 3.0V, SOTiny™ Single-Supply 0.4Ω SPST (NO) CMOS Analog Switch

### Features

- Low On-Resistance: 0.4Ω Max (+2.7V Supply)
- 0.1Ω Max. On-Resistance Flatness at +25°C
- Fast Switching: 10ns Max.
- +1.5V to +3.6V Single-Supply Operation
- TTL/CMOS-Logic Compatible
- -25dB Off-Isolation at 100kHz
- 1nA Max. Off-Leakage at +25°C
- Packaging (Pb-free & Green available):
  - 5-pin Small Compact SOT-23 (T)
  - 6-pin TDFN (ZC)

### Applications

- Cellular Phones
- Communications Circuits
- Battery-Operated Equipment
- DSL Modems
- Audio and Video Signal Routing
- PCMCIA Cards

### Pin Description

TDFN	SOT-23	Name	Function
1	1	COM	Analog Switch, Common
2	2	NO	Analog Switch, Normally Open
3	3	GND	Ground
4	4	IN	Digital Control Input
6	5	V <sub>CC</sub>	Positive Supply Voltage
5	-	N.C.	No Internal Connection

#### Note:

1. NO and COM pins are identical and interchangeable. Any pin may be considered as an input or an output; signals pass.

### Truth Table

Input	Switch State
LOW	OFF
HIGH	ON

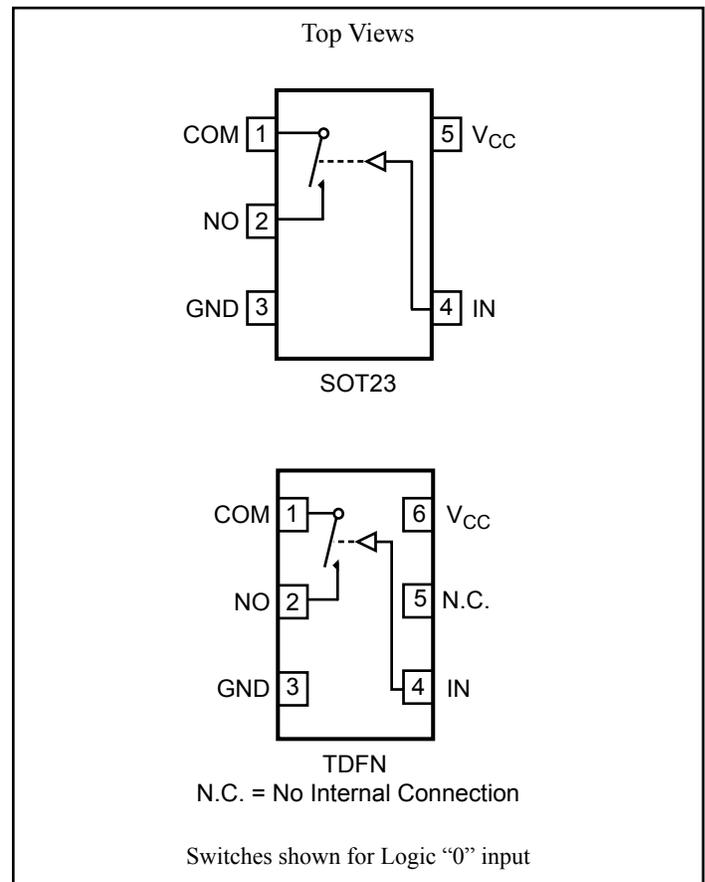
### Description

PI3A4626 is a single-pole/single-throw (SPST) normally open (NO) analog switch that operates from a single +1.5V to +3.6V supply.

The switch has 0.4Ω Max On-Resistance ( $R_{ON}$ ), with 0.1Ω Max  $R_{ON}$  flatness over the analog signal range when powered from a +3.0V supply. Leakage currents are less than 2nA and fast switching times are less than 10ns.

To minimize PC board area use, the device is available in the ultra compact TDFN, and the small compact SOT-23 packages.

### Block Diagrams/Pin Configurations



### Absolute Maximum Ratings

Voltages Referenced to GND  
 $V_{CC}$  ..... -0.5V to +3.6V  
 $V_{IN}$ ,  $V_{COM}$ ,  $V_{NC}$ ,  $V_{NO}$  <sup>(1)</sup> ..... -0.5V to  $V_{CC} + 0.3V$   
 or 30mA, whichever occurs first  
 Current (any terminal)..... ±200mA  
 Peak Current, COM, NO, NC  
 (Pulsed at 1ms, 10% duty cycle)..... ±400mA

### Thermal Information

Continuous Power Dissipation  
 SOT-23 (derate 7.1mW/°C above +70°C)..... 0.5W  
 Storage Temperature ..... -65°C to +150°C  
 Lead Temperature (soldering, 10s) ..... +300°C

#### Note:

1. Signals on NC, NO, COM, or IN exceeding  $V_{CC}$  or GND are clamped by internal diodes. Limit forward diode current to 30mA.

**Caution:** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.

### Electrical Specifications - Single +3.3V Supply

( $V_{CC} = +3.3V \pm 10\%$ ,  $GND = 0V$ ,  $V_{IH} = 1.4V$ ,  $V_{IL} = 0.5V$ )

Description	Parameters	Test Conditions	Package	Temp.(°C)	Min. <sup>(1)</sup>	Typ. <sup>(2)</sup>	Max. <sup>(1)</sup>	Units
<b>Analog Switch</b>								
Analog Signal Range <sup>(3)</sup>	$V_{ANALOG}$			Full	0		$V_{CC}$	V
On Resistance	$R_{ON}$	$V_{CC} = 2.7V$ , $I_{COM} = 100mA$ , $V_{NO}$ or $V_{NC} = +1.5V$	SOT23	25			0.4	$\Omega$
			TDFN	Full			0.5	
	25						0.6	
			Full			0.05		
On-Resistance Match Between Channels <sup>(4)</sup>	$\Delta R_{ON}$			25			0.06	
On-Resistance Flatness <sup>(5)</sup>	$R_{FLAT(ON)}$	$V_{CC} = 2.7V$ $I_{COM} = 100mA$ , $V_{NO}$ or $V_{NC} = 0.8V$ , $2.0V$		25			0.1	$\Omega$
				Full			0.1	
	25						1	
			Full			10		
NO or NC Off Leakage Current <sup>(6)</sup>	$I_{COM(OFF)}$ or $I_{NC(OFF)}$	$V_{CC} = 3.3V$ , $V_{COM} = 0V$ , $V_{NO}$ or $V_{NC} = +2.0V$		25	-1		1	nA
COM On Leakage Current <sup>(6)</sup>	$I_{COM(ON)}$	$V_{CC} = 3.3V$ , $V_{COM} = +2.0V$ , $V_{NO}$ or $V_{NC} = +2.0V$		25	-2		2	
				Full			20	
					Full			20

**Electrical Specifications - Single +3.3V Supply (continued)**

 (V<sub>CC</sub> = + 3.3V ± 10%, GND = 0V, V<sub>IH</sub> = 1.4V, V<sub>IL</sub> = 0.5V)

Description	Parameters	Test Conditions	Temp (°C)	Min. <sup>(1)</sup>	Typ. <sup>(2)</sup>	Max. <sup>(1)</sup>	Units
<b>Logic Input</b>							
Input High Voltage	V <sub>IH</sub>	Guaranteed logic High Level	Full	1.4			V
Input Low Voltage	V <sub>IL</sub>	Guaranteed logic Low Level				0.5	
Input Current with Voltage High	I <sub>INH</sub>	V <sub>IN</sub> = 1.4V, all others = 0.5V		-1		1	μA
Input Current with Voltage Low	I <sub>INL</sub>	V <sub>IN</sub> = 0.5V, all other = 1.4V		-1		1	
<b>Dynamic</b>							
Turn-On Time	t <sub>ON</sub>	V <sub>CC</sub> = 3.3V, V <sub>NO</sub> or V <sub>NC</sub> = 2.0V, Figure 1	25			10	ns
			Full			10	
Turn-Off Time	t <sub>OFF</sub>		25			10	
			Full			10	
Charge Injection <sup>(3)</sup>	Q	C <sub>L</sub> = 1nF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω, Figure 2	25		50		pC
Off Isolation <sup>(7)</sup>	O <sub>IRR</sub>	R <sub>L</sub> = 50Ω, f = 100KHz, Figure 3			-25		dB
NC or NO Capacitance	C <sub>(OFF)</sub>	f = 1 MHz, Figure 4			130		pF
COM Off Capacitance	C <sub>COM(OFF)</sub>				130		
COM On Capacitance	C <sub>COM(ON)</sub>				270		
<b>Supply</b>							
Power Supply Range	V <sub>CC</sub>		Full	1.5		3.6	V
Positive Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 3.6V, V <sub>IN</sub> = 0V or V <sub>CC</sub>				100	nA

**Notes:**

1. The algebraic convention, where most negative value is a minimum and most positive is a maximum, is used in this data sheet.
2. Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.
3. Guaranteed by design.
4. ΔR<sub>ON</sub> = R<sub>ON</sub> Max. - R<sub>ON</sub> Min.
5. Flatness is defined as the difference between the maximum and minimum value of On-Resistance measured.
6. Leakage parameters are 100% tested at maximum rated hot temperature and guaranteed by correlation at +25°C.
7. Off Isolation = 20log<sub>10</sub> [ V<sub>COM</sub> / (V<sub>NO</sub> or V<sub>NC</sub>) ]. See Figure 3.

**Electrical Specifications - Single +2.5V Supply**

 (V<sub>CC</sub> = +2.5V ± 10%, GND = 0V, V<sub>IH</sub> = 1.4V, V<sub>IL</sub> = 0.5V)

Description	Parameters	Test Conditions	Temp.(°C)	Min. <sup>(1)</sup>	Typ. <sup>(2)</sup>	Max. <sup>(1)</sup>	Units
<b>Analog Switch</b>							
Analog Signal Range <sup>(3)</sup>	V <sub>ANALOG</sub>			0		V <sub>CC</sub>	V
On-Resistance	R <sub>ON</sub>	V <sub>CC</sub> = 2.5V, I <sub>COM</sub> = -8mA, V <sub>NO</sub> or V <sub>NC</sub> = 1.8V	25			0.4	Ω
			Full			0.4	
On-Resistance Match Between Channels <sup>(4)</sup>	ΔR <sub>ON</sub>	V <sub>CC</sub> = 2.5V, I <sub>COM</sub> = -8mA, V <sub>NO</sub> or V <sub>NC</sub> = 0.8V, 1.8V	25			0.05	
			Full			0.06	
On-Resistance Flatness <sup>(5)</sup>	R <sub>FLAT(ON)</sub>	V <sub>CC</sub> = 2.5V, I <sub>COM</sub> = -8mA, V <sub>NO</sub> or V <sub>NC</sub> = 0.8V, 1.8V	25			0.1	
			Full			0.1	
<b>Dynamic</b>							
Turn-On Time	t <sub>ON</sub>	V <sub>CC</sub> = 2.5V, V <sub>NO</sub> or V <sub>NC</sub> = 1.8V, Figure 1	25			10	ns
			Full			15	
Turn-Off Time	t <sub>OFF</sub>		25			10	
			Full			10	
Charge Injection <sup>(3)</sup>	Q	C <sub>L</sub> = 1nF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0V, Figure 2	25		42		pC
<b>Logic Input</b>							
Input HIGH Voltage	V <sub>IH</sub>	Guaranteed logic high level	Full	1.4			V
Input LOW Voltage	V <sub>IL</sub>	Guaranteed logic Low level	Full			0.5	
Input HIGH Current	I <sub>INH</sub>	V <sub>IN</sub> = 1.4V, all others = 0.5V	Full	-1		1	μA
Input HIGH Current	I <sub>INL</sub>	V <sub>IN</sub> = 0.5V, all others = 1.4V	Full	-1		1	

**Notes:**

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2. Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.
3. Guaranteed by design.
4. ΔR<sub>ON</sub> = R<sub>ON</sub> max. - R<sub>ON</sub> min.
5. Flatness is defined as the difference between the maximum and minimum value of On-Resistance measured.

**Electrical Specifications - Single +1.8V Supply**

 (V<sub>CC</sub> = +1.8V ± 10%, GND = 0V, V<sub>IH</sub> = 1.4V, V<sub>IL</sub> = 0.5V)

Description	Parameters	Test Conditions	Temp.(°C)	Min. <sup>(1)</sup>	Typ. <sup>(2)</sup>	Max. <sup>(1)</sup>	Units		
<b>Analog Switch</b>									
Analog Signal Range <sup>(3)</sup>	V <sub>ANALOG</sub>			0		V <sub>CC</sub>	V		
On-Resistance	R <sub>ON</sub>	V <sub>CC</sub> = 1.8V, I <sub>COM</sub> = -4mA, V <sub>NO</sub> or V <sub>NC</sub> = 1.5V	25			0.4	Ω		
			Full			0.8			
On-Resistance Match Between Channels <sup>(4)</sup>	ΔR <sub>ON</sub>	V <sub>CC</sub> = 1.8V, I <sub>COM</sub> = -4mA, V <sub>NO</sub> or V <sub>NC</sub> = 0.8V, 1.5V	25			0.05			
			Full			0.06			
On-Resistance Flatness <sup>(5)</sup>	R <sub>FLAT(ON)</sub>		25			0.4			
			Full			0.6			
<b>Dynamic</b>									
Turn-On Time	t <sub>ON</sub>	V <sub>CC</sub> = 1.8V, V <sub>NO</sub> or V <sub>NC</sub> = 1.5V, Figure 1	25			15	ns		
			Full			15			
Turn-Off Time	t <sub>OFF</sub>		25			10			
			Full			15			
Charge Injection <sup>(3)</sup>	Q		CL = 1nF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0V, Figure 2	25		29			pC
<b>Logic Input</b>									
Input HIGH Voltage	V <sub>IH</sub>	Guaranteed logic high level	Full	1.4			V		
Input LOW Voltage	V <sub>IL</sub>	Guaranteed logic Low level	Full			0.5			
Input HIGH Current	I <sub>INH</sub>	V <sub>IN</sub> = 1.4V, all others = 0.5V	Full	-1		1	μA		
Input HIGH Current	I <sub>INL</sub>	V <sub>IN</sub> = 0.5V, all others = 1.4V	Full	-1		1			

**Notes:**

1. The algebraic convention, where most negative value is a minimum and most positive is a maximum, is used in this data sheet.
2. Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.
3. Guaranteed by design.
4. ΔR<sub>ON</sub> = R<sub>ON</sub> max. - R<sub>ON</sub> min.
5. Flatness is defined as the difference between the maximum and minimum value of On-Resistance measured.

Test Circuits/Timing Diagrams

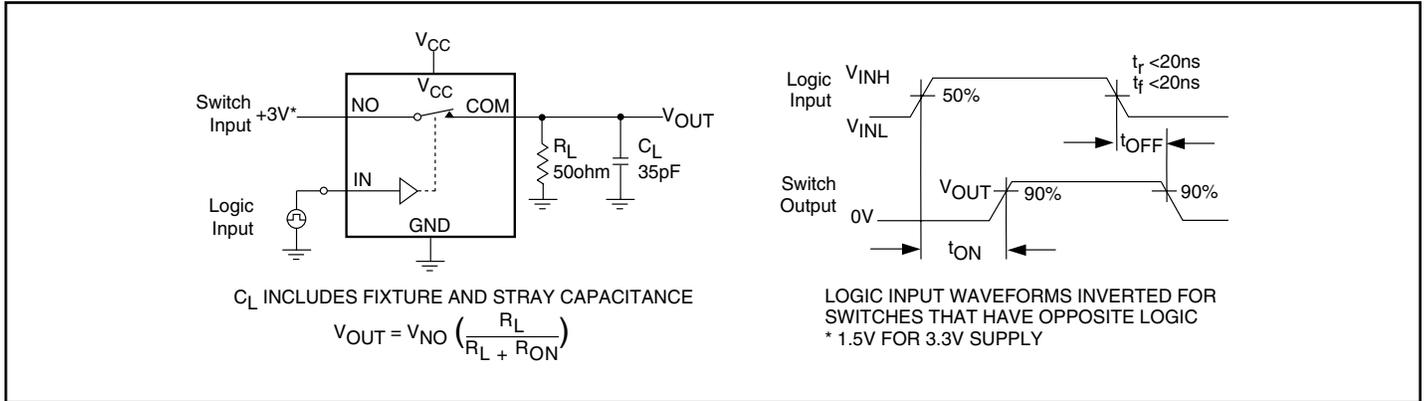


Figure 1. Switching Time

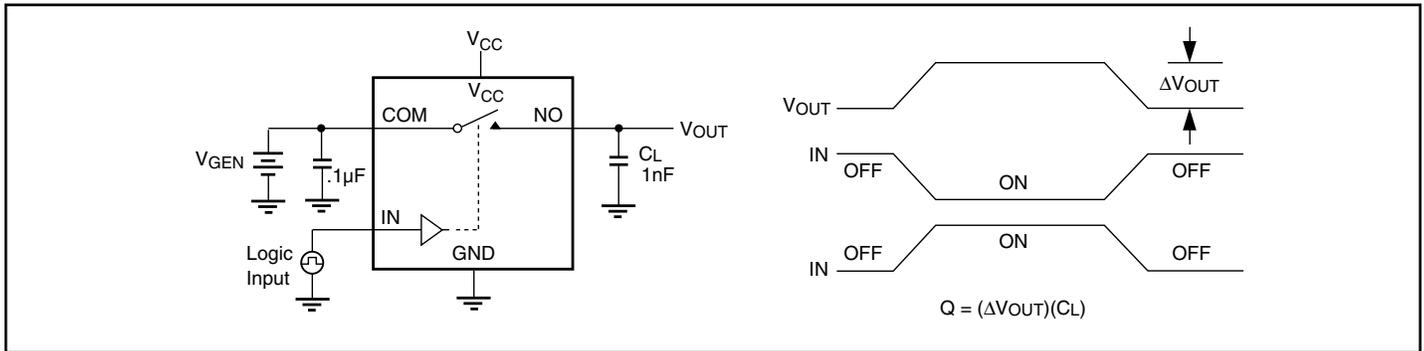


Figure 2. Charge Injection

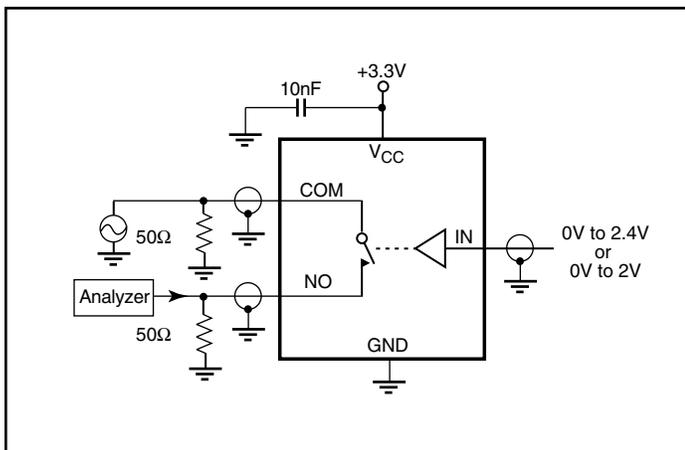


Figure 3. Off Isolation

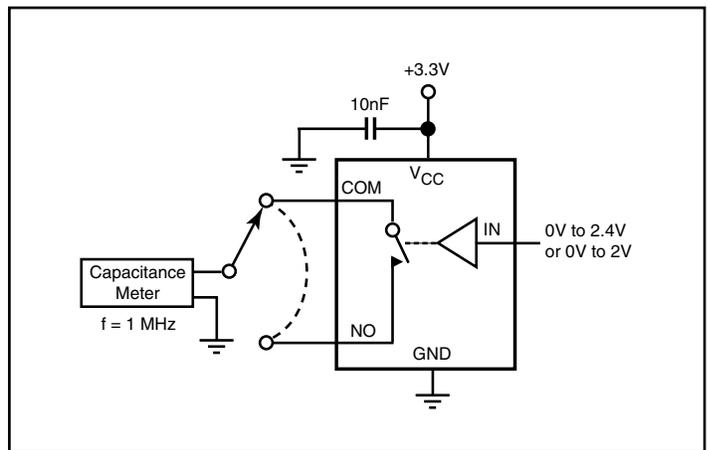
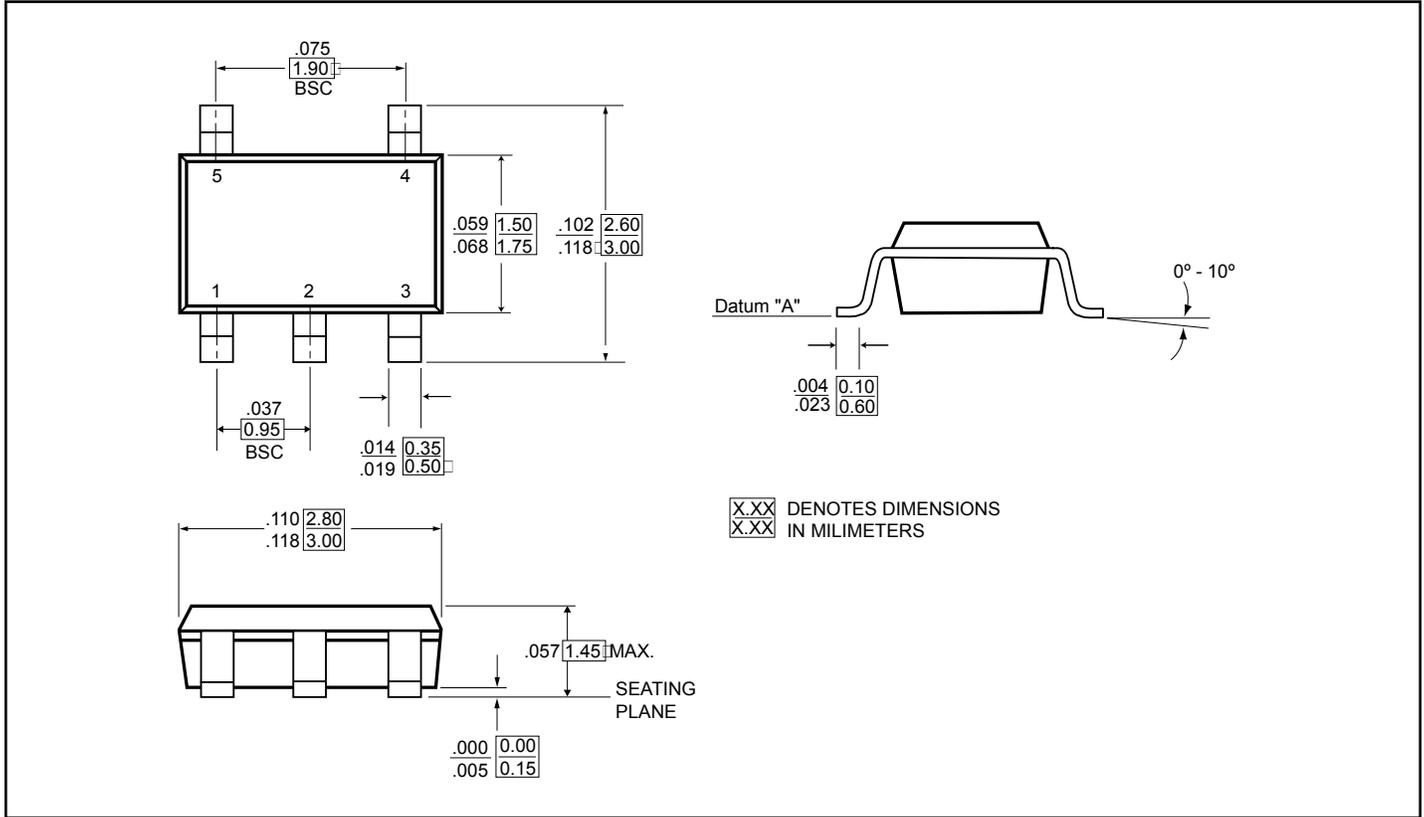
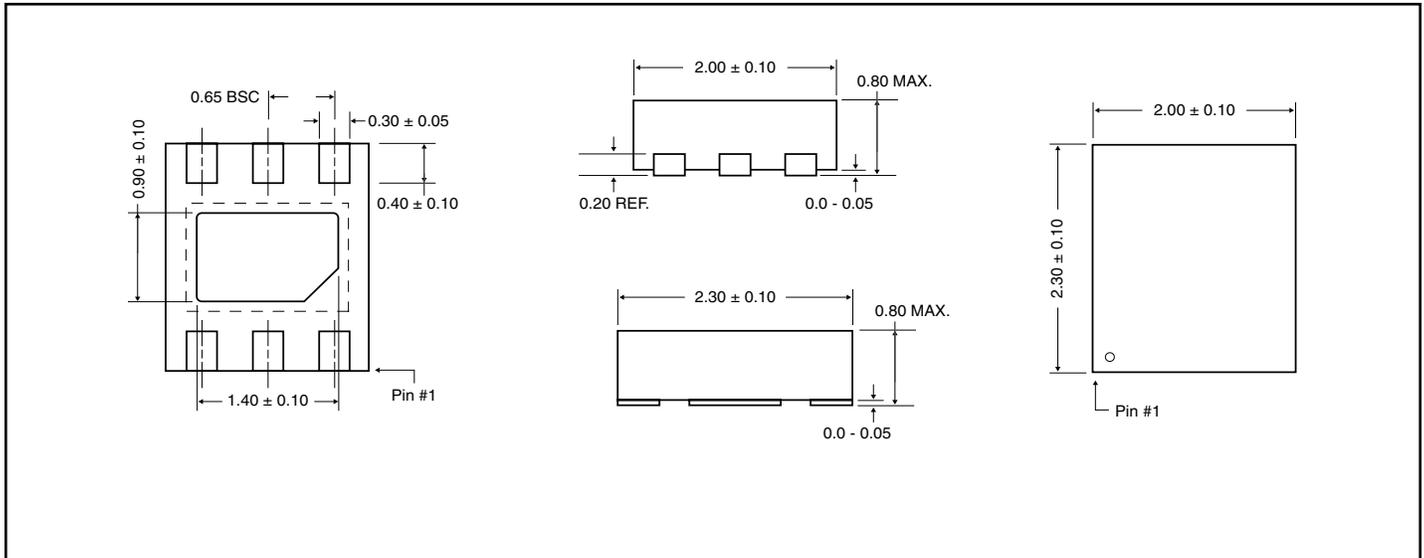


Figure 4. Channel On/Off Capacitance

**Packaging Mechanical: 5-Pin SOT-23 (T)**



**Packaging Mechanical: 6-Pin TDFN (ZC)**





### Ordering Information

Ordering Code	Packaging Code	Package Description	Top Mark
PI3A4626TX	T	5-pin Small Compact SOT-23	ZD
PI3A4626TEX	T	Pb-free & Green, 5-pin Small Compact SOT-23	ZD
PI3A4626ZCEX	ZC	Pb-free & Green, 6-pin Ultra Compact TDFN	ZD

**Notes:**

1. Thermal characteristics can be found on the company web site at [www.pericom.com/packaging/](http://www.pericom.com/packaging/)
2. X = Tape/Reel
3. Number of transistors = TBD